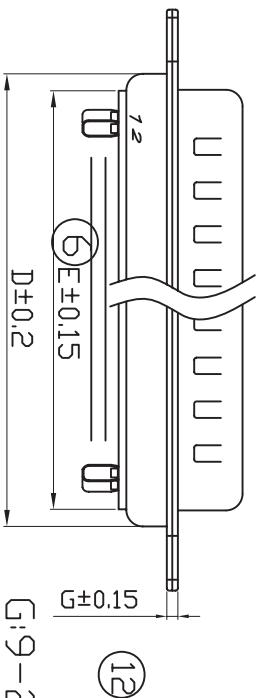
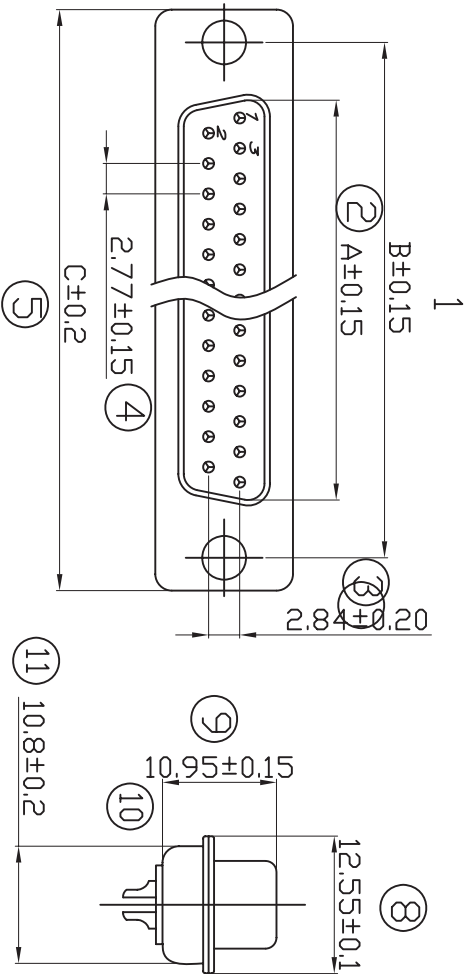


REV.	DESCRIPTION	DATE
A/0	原始版本	2003. 10. 13
A/1		

	A	B	C	D	E
09	16.92	24.99	30.81	19.28	15.60
15	25.25	33.32	39.14	27.65	24.60
25	38.96	47.04	53.04	41.10	37.70
37	55.42	63.50	69.32	57.44	54.50



G:9-25P=0.75
37P=0.85

备注

1.性能

额定电压 250V
额定电流 5AMP
接触阻抗 20mΩ MAX.
绝缘阻抗 1000MΩ MIN.at 500V DC
耐电压 500V Per minute
温度范围 -55°C~105°C

2.材质

胶芯: PBT+30% G.F(UL94V-0)
端子: C2680-H T=0.2 镀半金锡
铁壳: SPCC 9-25P T=0.35
37P T=0.4 前壳电镀/后壳镀锡

注: “*”为检测尺寸,其余为参考值.

A	前脚型 (不透孔)	B	后脚型 (透孔)

深圳市威鑫联电子有限公司			
X. ±0.25 XX ±0.20 XXX ±0.15 XXXX ±0.10 X* ±1°		DRAWN BY: DATE: PART NAME: DB(公)一体焊线式	
X. ±0.25 XX ±0.20 XXX ±0.15 XXXX ±0.10 X* ±1°		CHECKED BY: DATE: 2003. 10. 13	
UNTT. mm [inch]		APPROVAL BY: DATE:	
SCALE: 1:1		SIZE: A4	
PART NO.		MOLD NO.	
PRODUCT SPEC.		DRAW NO.	